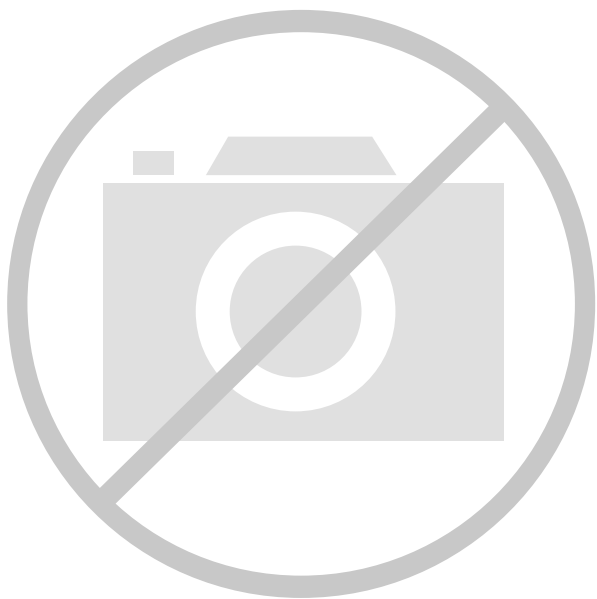




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Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

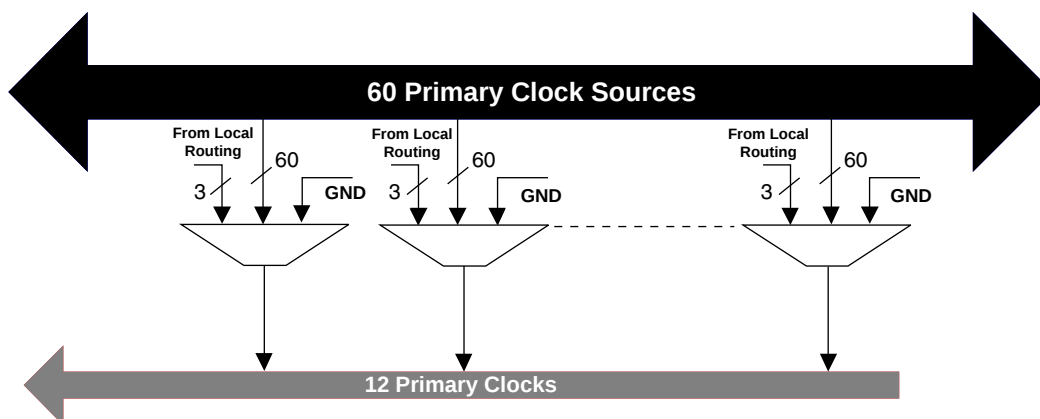
Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

Product Status	Obsolete
Number of LABs/CLBs	28750
Number of Logic Elements/Cells	115000
Total RAM Bits	7987200
Number of I/O	660
Number of Gates	-
Voltage - Supply	0.95V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 105°C (TJ)
Package / Case	1152-BCBGA, FCBGA
Supplier Device Package	1152-CFCBGA (35x35)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfscm3ga115ep1-6fc1152i

Figure 2-6. Per Quadrant Clock Selection

Note: GND is available to switch off the network.

Secondary Clocks

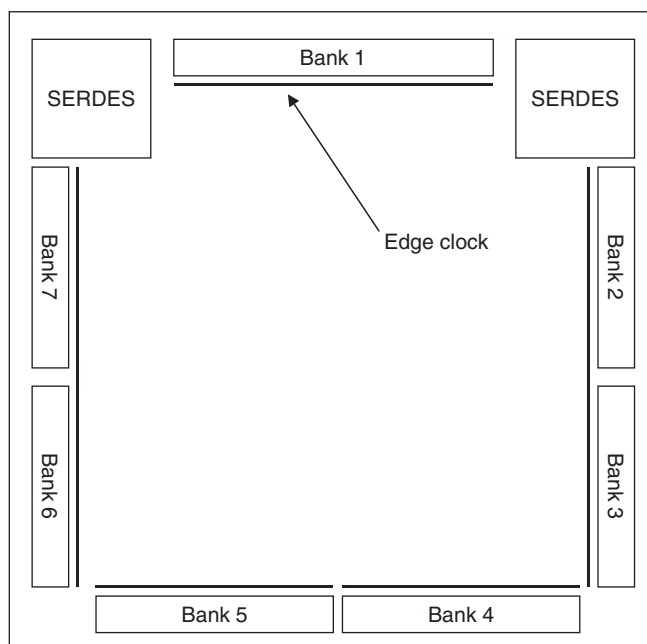
In addition to the primary clock network and edge clocks the LatticeSC devices also contain a secondary clock network. Built of X6 style routing elements this secondary clock network is ideal for routing slower speed clock and control signals throughout the device preserving high-speed clock networks for the most timing critical signals.

Edge Clocks

LatticeSC devices have a number of high-speed edge clocks that are intended for use with the PIOs in the implementation of high-speed interfaces. There are eight edge clocks per bank for the top and bottom of the device. The left and right sides have eight edge clocks per side for both banks located on that side. Figure 2-7 shows the arrangement of edge clocks.

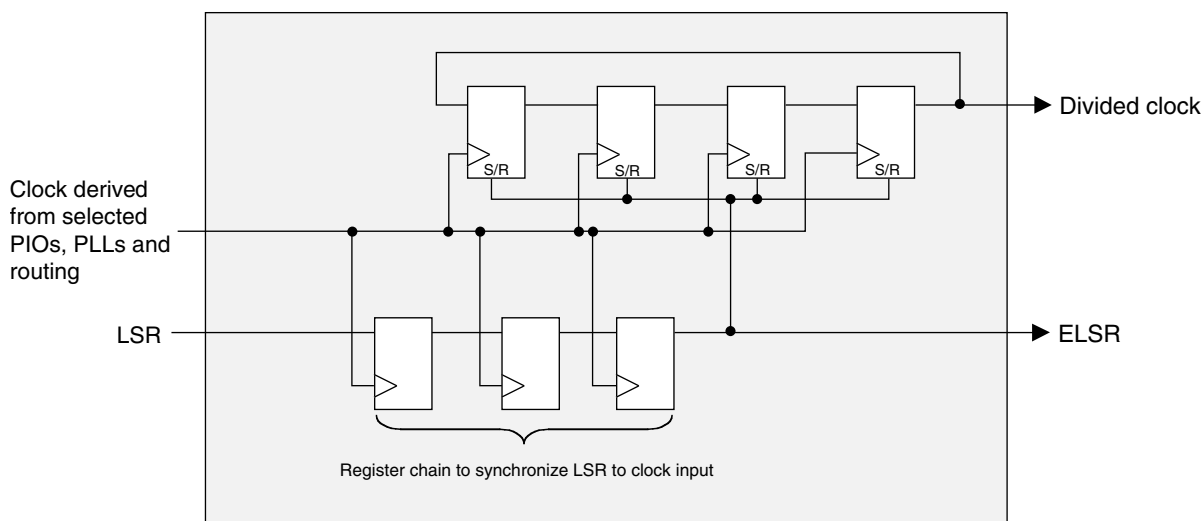
Edge clock resources can be driven from a variety of sources. Edge clock resources can be driven from:

- Edge clock PIOs in the same bank
- Primary clock PIOs in the same bank
- Routing
- Adjacent PLLs and DLLs
- ELSR output from the clock divider

Figure 2-7. Edge Clock Resources

Precision Clock Divider

Each set of edge clocks has four high-speed dividers associated with it. These are intended for generating a slower speed system clock from the high-speed edge clock. The block operates in a DIV2 or DIV4 mode and maintains a known phase relationship between the divided down clock and high-speed clock based on the release of its reset signal. The clock dividers can be fed from selected PIOs, PLLs and routing. The clock divider outputs serve as primary clock sources. This circuit also generates an edge local set/reset (ELSR) signal which is fed to the PIOs via the edge clock network and is used for the rest of the I/O gearing logic.

Figure 2-8. Clock Divider Circuit

Dynamic Clock Select (DCS)

The DCS is a global clock buffer with smart multiplexer functions. It takes two independent input clock sources and outputs a clock signal without any glitches or runt pulses. This is achieved irrespective of where the select signal is

Absolute Maximum Ratings

Supply Voltage V_{CC} , V_{CC12} , V_{DDIB} , V_{DDOB}	-0.5 to 1.6V
Supply Voltage V_{CCAUX} , V_{DDAX25} , V_{TT}	-0.5 to 2.75V
Supply Voltage V_{CCJ}	-0.5 to 3.6V
Supply Voltage V_{CCIO} (Banks 1, 4, 5)	-0.5 to 3.6V
Supply Voltage V_{CCIO} (Banks 2, 3, 6, 7)	-0.5 to 2.75V
Input or I/O Tristate Voltage Applied (Banks 1, 4, 5)	-0.5 to 3.6V
Input or I/O Tristate Voltage Applied (Banks 2, 3, 6, 7)	-0.5 to 2.75V
Storage Temperature (Ambient)	-65 to 150°C
Junction Temperature Under Bias (Tj)	+125°C

Notes:

1. Stress above those listed under the "Absolute Maximum Ratings" may cause permanent damage to the device. Functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.
2. Compliance with the Lattice Thermal Management document is required.
3. All voltages referenced to GND.
4. Undershoot and overshoot of -2V to (VIHMAX +2) volts is permitted for a duration of <20ns.

Recommended Operating Conditions

Symbol	Parameter	Min.	Max.	Units
V_{CC}^5	Core Supply Voltage (Nominal 1.2V Operation)	0.95	1.26	V
V_{CCAUX}^6	Programmable I/O Auxiliary Supply Voltage	2.375	2.625	V
$V_{CCIO}^{1,2,5,6}$	Programmable I/O Driver Supply Voltage (Banks 1, 4, 5)	1.14	3.45	V
$V_{CCIO}^{1,2,5,6}$	Programmable I/O Driver Supply Voltage (Banks 2, 3, 6, 7)	1.14	2.625	V
$V_{CC12}^{4,5}$	Internal 1.2V Power Supply Voltage for Configuration Logic and FPGA PLL, SERDES PLL Power Supply Voltage and SERDES Analog Supply Voltage	1.14	1.26	V
V_{DDIB}	SERDES Input Buffer Supply Voltage	1.14	1.575	V
V_{DDOB}	SERDES Output Buffer Supply Voltage	1.14	1.575	V
V_{DDAX25}	SERDES Termination Auxiliary Supply Voltage	2.375	2.625	V
$V_{CCJ}^{1,5}$	Supply Voltage for IEEE 1149.1 Test Access Port	1.71	3.45	V
$V_{TT}^{2,3}$	Programmable I/O Termination Power Supply	0.5	$V_{CCAUX} - 0.5$	V
t_{JCOM}	Junction Temperature, Commercial Operation	0	+85	C
t_{JIND}	Junction Temperature, Industrial Operation	-40	105	C

1. If V_{CCIO} or V_{CCJ} is set to 2.5V, they must be connected to the same power supply as V_{CCAUX} .
2. See recommended voltages by I/O standard in subsequent table.
3. When V_{TT} termination is not required, or used to provide the common mode termination voltage (V_{CMT}), these pins can be left unconnected on the device.
4. V_{CC12} cannot be lower than V_{CC} at any time. For 1.2V operation, it is recommended that the V_{CC} and V_{CC12} supplies be tied together with proper noise decoupling between the digital VCC and analog VCC12 supplies.
5. V_{CC} , V_{CCIO} (all banks), V_{CC12} and V_{CCJ} must reach their minimum values before configuration will proceed.
6. If V_{CCIO} for a bank is nominally 1.2V/1.5V/1.8V, then V_{CCAUX} must always be higher than V_{CCIO} during power up.

Figure 3-8. Read Mode with Input and Output Registers

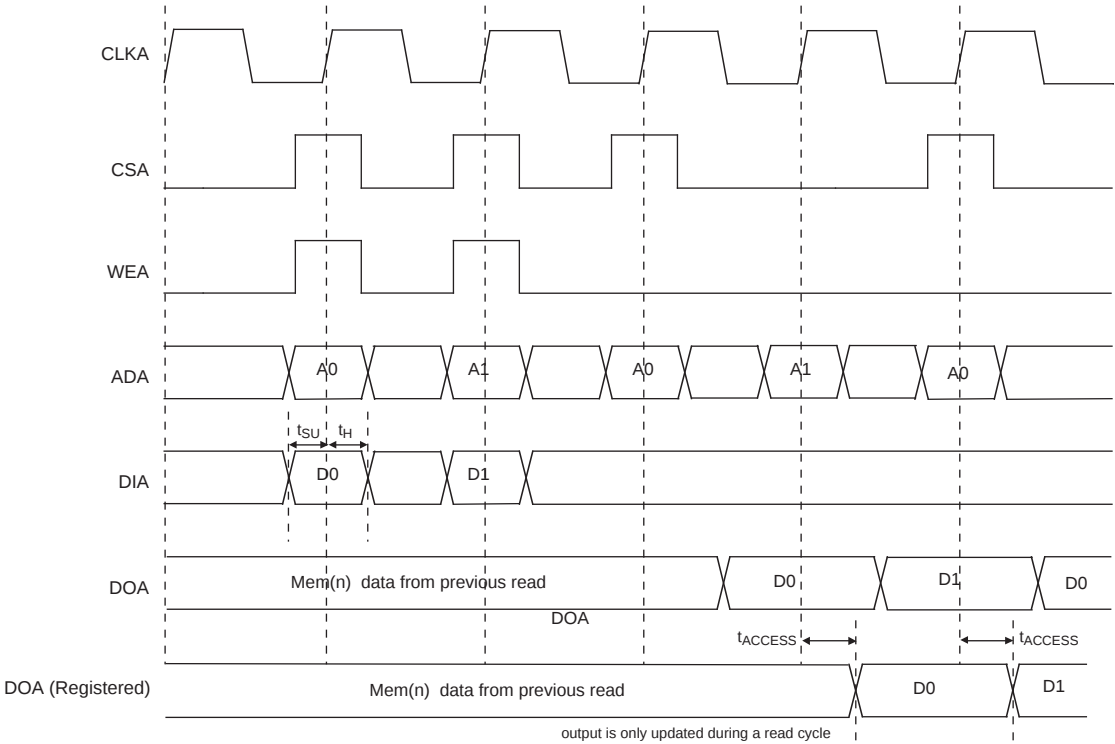
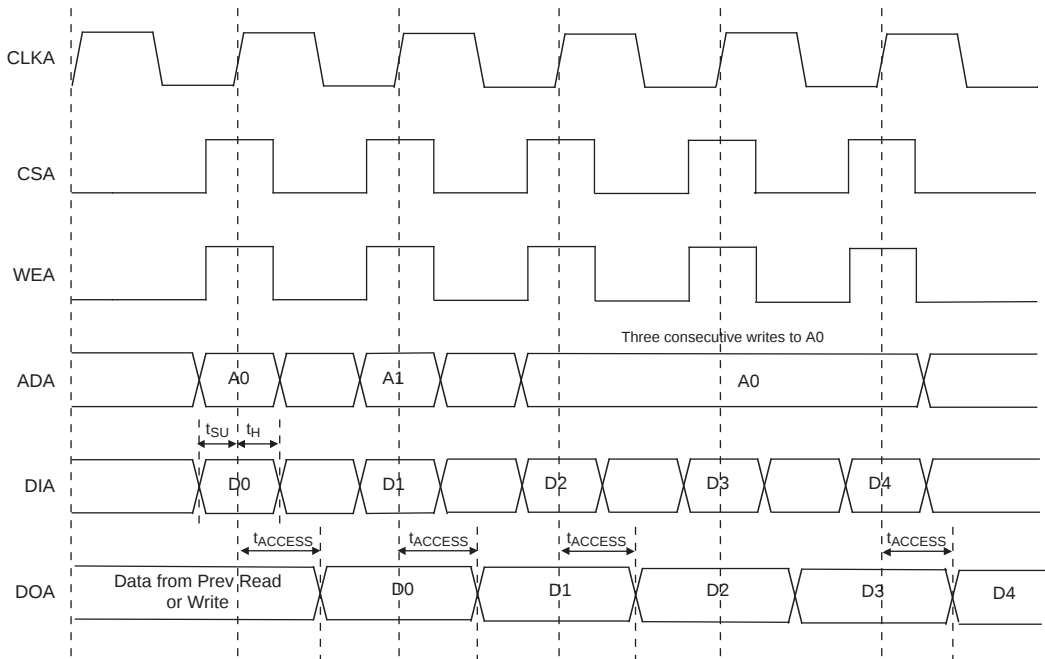


Figure 3-9. Write Through (SP Read/Write On Port A, Input Registers Only)

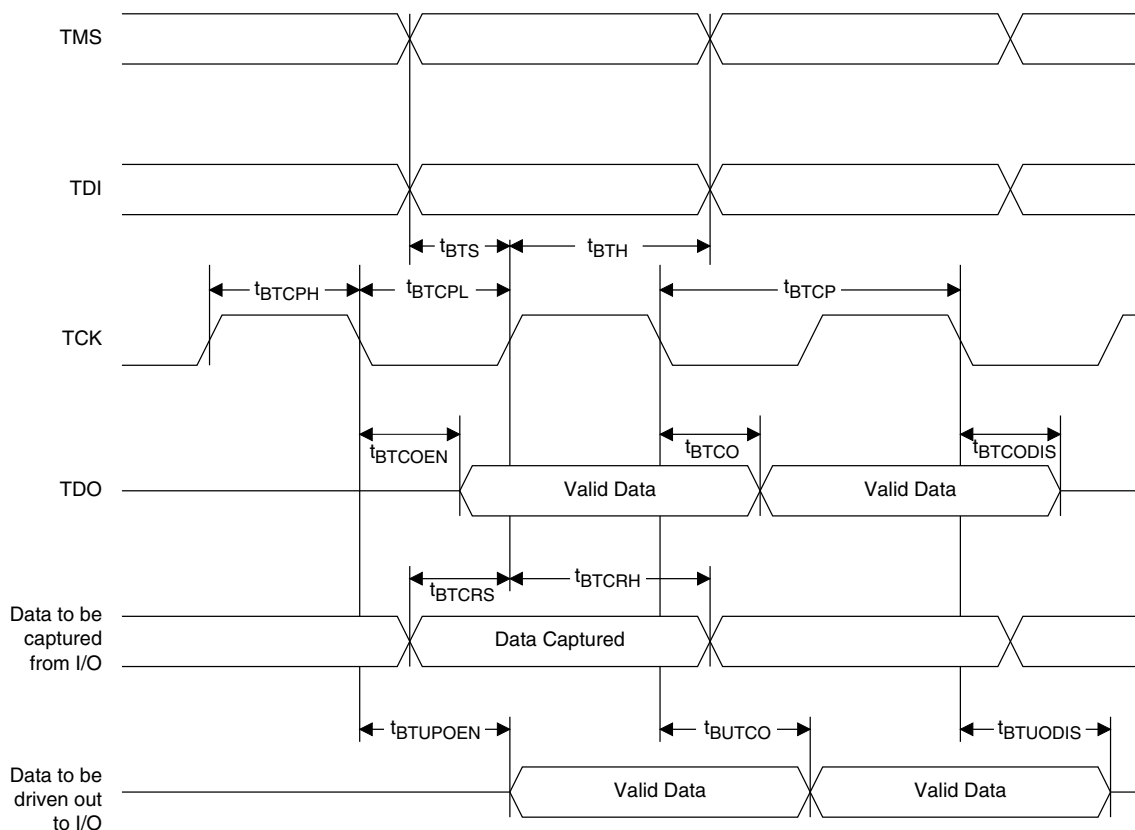


Note: Input data and address are registered at the positive edge of the clock and output data appears after the positive of the clock.

JTAG Port Timing Specifications

Over Recommended Operating Conditions

Symbol	Parameter	Min.	Max.	Units
f_{MAX}		—	25	MHz
t_{BTCP}	TCK [BSCAN] Clock Pulse Width	40	—	ns
t_{BTCPH}	TCK [BSCAN] Clock Pulse Width High	20	—	ns
t_{BTCPL}	TCK [BSCAN] Clock Pulse Width Low	20	—	ns
t_{BTS}	TCK [BSCAN] Setup Time	8	—	ns
t_{BTH}	TCK [BSCAN] Hold Time	10	—	ns
t_{BTRF}	TCK [BSCAN] Rise/Fall Time	50	—	mV/ns
t_{BTCO}	TAP Controller Falling Edge of Clock to Valid Output	—	10	ns
$t_{BTCODIS}$	TAP Controller Falling Edge of Clock to Valid Disable	—	10	ns
t_{BTCOEN}	TAP Controller Falling Edge of Clock to Valid Enable	—	10	ns
t_{BTCRS}	BSCAN Test Capture Register Setup Time	8	—	ns
t_{BTCRH}	BSCAN Test Capture Register Hold Time	10	—	ns
t_{BUTCO}	BSCAN Test Update Register, Falling Edge of Clock to Valid Output	—	25	ns
$t_{BTUODIS}$	BSCAN Test Update Register, Falling Edge of Clock to Valid Disable	—	25	ns
$t_{BTUPOEN}$	BSCAN Test Update Register, Falling Edge of Clock to Valid Enable	—	25	ns

Figure 3-14. JTAG Port Timing Waveforms

Signal Descriptions

Signal Name	I/O	Description
General Purpose		
P[Edge] [Row/Column Number*]_[A/B/C/D]	I/O	[Edge] indicates the edge of the device on which the pad is located. Valid edge designations are L (Left), B (Bottom), R (Right), T (Top). [Row/Column Number] indicates the PIC row or the column of the device on which the PIC exists. When Edge is T (Top) or (Bottom), only need to specify Row Number. When Edge is L (Left) or R (Right), only need to specify Column Number. [A/B/C/D] indicates the PIO within the PIC to which the pad is connected. Some of these user programmable pins are shared with special function pins. These pin when not used as special purpose pins can be programmed as I/Os for user logic. During configuration the user-programmable I/Os are tri-stated with an internal pull-up resistor enabled. If any pin is not used (or not bonded to a package pin), it is also tri-stated with an internal pull-up resistor enabled after configuration.
VREF1_x, VREF2_x	—	The reference supply pins for I/O bank x. Any I/O pin in a bank can be assigned as a reference supply pin, but software defaults use designated pin.
NC	—	No connect. NC pins should not be connected to any active signals, VCC or GND.
Non-SERDES Power Supplies		
VCCIOx	—	VCCIO - The power supply pins for I/O bank x. Dedicated pins.
VCC12 ¹	—	1.2V supply for configuration logic, PLLs and SERDES Rx, Tx and PLL. All VCC12 pins must be connected. As VCC12 supplies power for analog circuitry, VCC12 should be quiet and isolated from noisy digital board supplies.
VTT_x	—	Termination voltage for bank x. When VTT termination is not required, or used to provide the common mode termination voltage (VCMT), these pins can be left unconnected on the device. VCMT function is not used in the bank. If the internal or external VCMT function for differential input termination is used, the VTT pins should be unconnected and allowed to float.
GND	—	GND - Ground. Dedicated pins. All grounds must be electrically connected at the board level.
VCC	—	VCC - The power supply pins for core logic. Dedicated pins (1.2V/1.0V).
VCCAUX	—	VCCAUX - Auxiliary power supply pin - powers all differential and referenced input buffers. Dedicated pins (2.5V).
VCCJ	—	VCCJ - The power supply pin for JTAG Test Access Port.
PROBE_VCC	—	VCC signal - Connected to internal VCC node. Can be used for feedback to control an external board power converter. Can be unconnected if not used.

Pin Information Summary (Cont.)

Pin Type		1152 fcBGA			1704 fcBGA	
		LFSC/M40	LFSC/M80	LFSC/M115	LFSC/M80	LFSC/M115
Single Ended User I/O		604	660	660	904	942
Differential Pair User I/O		302	330	330	452	470
LVDS Output Pairs		78	102	102	114	132
Configuration	Dedicated	11	11	11	11	11
	Muxes/MPI sysBus	72	72	72	72	72
JTAG (excluding VCCJ)		4	4	4	4	4
Dedicated Pins		4	4	4	4	4
VCC		44	44	44	76	76
VCC12		52	52	52	88	88
VCCAUX		38	38	38	52	52
VCCIO	Bank 1	10	10	10	10	10
	Bank 2	9	9	9	12	12
	Bank 3	12	12	12	14	14
	Bank 4	12	12	12	14	14
	Bank 5	12	12	12	14	14
	Bank 6	12	12	12	14	14
	Bank 7	9	9	9	12	12
VTT	Bank 2	3	3	3	4	4
	Bank 3	3	3	3	4	4
	Bank 4	3	3	3	5	5
	Bank 5	3	3	3	5	5
	Bank 6	3	3	3	4	4
	Bank 7	3	3	3	4	4
GND		130	130	130	184	184
NC		62	6	6	52	14
Single Ended User / Differential I/O per Bank	Bank 1	80/40	80/40	80/40	80/40	80/40
	Bank 2	60/30	76/38	76/38	96/48	103/51
	Bank 3	96/48	108/54	108/54	132/66	144/72
	Bank 4	106/53	106/53	106/53	184/92	184/92
	Bank 5	106/53	106/53	106/53	184/92	184/92
	Bank 6	96/48	108/54	108/54	132/66	144/72
	Bank 7	60/30	76/38	76/38	96/48	103/51
LVDS Output Pairs Per Bank	Bank 2	15	21	21	24	27
	Bank 3	24	30	30	33	39
	Bank 6	24	30	30	33	39
	Bank 7	15	21	21	24	27
VCCJ		1	1	1	1	1
SERDES (signal + power supply)		108	108	108	212	212
Total		1152	1152	1152	1704	1704

LFSC/M40, LFSC/M80 Logic Signal Connections: 1152 fcBGA^{1, 2} (Cont.)

Ball Number	LFSC/M40			LFSC/M80		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
V25	PL44C	6		PL56C	6	
W25	PL44D	6		PL56D	6	
U34	PL45A	6		PL57A	6	
V34	PL45B	6		PL57B	6	
V26	PL45C	6		PL57C	6	
W26	PL45D	6		PL57D	6	
V33	PL47A	6		PL60A	6	
W33	PL47B	6		PL60B	6	
V24	PL47C	6		PL60C	6	
W24	PL47D	6		PL60D	6	
W31	PL48A	6		PL63A	6	
Y31	PL48B	6		PL63B	6	
Y29	PL48C	6		PL63C	6	
AA29	PL48D	6		PL63D	6	
Y33	PL49A	6		PL65A	6	
AA33	PL49B	6		PL65B	6	
Y28	PL49C	6		PL65C	6	
AA28	PL49D	6		PL65D	6	
AB32	PL51A	6		PL76A	6	
AC32	PL51B	6		PL76B	6	
AA26	PL51C	6		PL76C	6	
AA27	PL51D	6	DIFFR_6	PL76D	6	DIFFR_6
AB31	PL52A	6		PL77A	6	
AC31	PL52B	6		PL77B	6	
Y24	PL52C	6		PL77C	6	
AA24	PL52D	6		PL77D	6	
AE34	PL53A	6		PL78A	6	
AF34	PL53B	6		PL78B	6	
AB30	PL53C	6		PL78C	6	
AC30	PL53D	6		PL78D	6	
AD33	PL56A	6		PL80A	6	
AE33	PL56B	6		PL80B	6	
AD30	PL56C	6		PL80C	6	
AE30	PL56D	6		PL80D	6	
AE32	PL57A	6		PL81A	6	
AF32	PL57B	6		PL81B	6	
AA25	PL57C	6		PL81C	6	
AB25	PL57D	6		PL81D	6	
AJ34	PL58A	6		PL82A	6	
AK34	PL58B	6		PL82B	6	
AB27	PL58C	6		PL82C	6	
AC27	PL58D	6		PL82D	6	
AF33	PL60A	6		PL84A	6	
AG33	PL60B	6		PL84B	6	
AC29	PL60C	6		PL84C	6	

LFSC/M40, LFSC/M80 Logic Signal Connections: 1152 fcBGA^{1, 2} (Cont.)

Ball Number	LFSC/M40			LFSC/M80		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
H21	PT38D	1	D28/PCLKC1_6/MPI_DATA28	PT57D	1	D28/PCLKC1_6/MPI_DATA28
J21	PT38C	1	D29/PCLKT1_6/MPI_DATA29	PT57C	1	D29/PCLKT1_6/MPI_DATA29
A19	PT38B	1	A9/MPI_ADDR23	PT57B	1	A9/MPI_ADDR23
B19	PT38A	1	A10/MPI_ADDR24	PT57A	1	A10/MPI_ADDR24
H22	PT37D	1	D30/PCLKC1_7/MPI_DATA30	PT56D	1	D30/PCLKC1_7/MPI_DATA30
J22	PT37C	1	D31/PCLKT1_7/MPI_DATA31	PT56C	1	D31/PCLKT1_7/MPI_DATA31
F20	PT37B	1	A11/MPI_ADDR25	PT56B	1	A11/MPI_ADDR25
G20	PT37A	1	A12/MPI_ADDR26	PT56A	1	A12/MPI_ADDR26
K21	PT35D	1	D11/MPI_DATA11	PT55D	1	D11/MPI_DATA11
K22	PT35C	1	D12/MPI_DATA12	PT55C	1	D12/MPI_DATA12
A20	PT35B	1	A13/MPI_ADDR27	PT55B	1	A13/MPI_ADDR27
B20	PT35A	1	A14/MPI_ADDR28	PT55A	1	A14/MPI_ADDR28
L21	PT33D	1	A16/MPI_ADDR30	PT53D	1	A16/MPI_ADDR30
L20	PT33C	1	D13/MPI_DATA13	PT53C	1	D13/MPI_DATA13
D20	PT33B	1	A15/MPI_ADDR29	PT53B	1	A15/MPI_ADDR29
E20	PT33A	1	A17/MPI_ADDR31	PT53A	1	A17/MPI_ADDR31
L19	PT30D	1	A19/MPI_TSI21	PT52D	1	A19/MPI_TSI21
K19	PT30C	1	A20/MPI_BDIP	PT52C	1	A20/MPI_BDIP
D21	PT30B	1	A18/MPI_TSI20	PT52B	1	A18/MPI_TSI20
E21	PT30A	1	MPI_TEA	PT52A	1	MPI_TEA
M20	PT28D	1	D14/MPI_DATA14	PT51D	1	D14/MPI_DATA14
M19	PT28C	1	DP1/MPI_PAR1	PT51C	1	DP1/MPI_PAR1
F21	PT27B	1	A21/MPI_BURST	PT51B	1	A21/MPI_BURST
G21	PT27A	1	D15/MPI_DATA15	PT51A	1	D15/MPI_DATA15
H24	B_REFCLKP_L	-		B_REFCLKP_L	-	
J24	B_REFCLKN_L	-		B_REFCLKN_L	-	
L22	VCC12	-		VCC12	-	
E26	B_VDDIB3_L	-		B_VDDIB3_L	-	
G22	VCC12	-		VCC12	-	
E22	B_HDINP3_L	-	PCS 361 CH 3 IN P	B_HDINP3_L	-	PCS 361 CH 3 IN P
F22	B_HDINN3_L	-	PCS 361 CH 3 IN N	B_HDINN3_L	-	PCS 361 CH 3 IN N
A21	B_HDOUTP3_L	-	PCS 361 CH 3 OUT P	B_HDOUTP3_L	-	PCS 361 CH 3 OUT P
L24	VCC12	-		VCC12	-	
B21	B_HDOUTN3_L	-	PCS 361 CH 3 OUT N	B_HDOUTN3_L	-	PCS 361 CH 3 OUT N
D22	B_VDDOB3_L	-		B_VDDOB3_L	-	
B22	B_HDOUTN2_L	-	PCS 361 CH 2 OUT N	B_HDOUTN2_L	-	PCS 361 CH 2 OUT N
D23	B_VDDOB2_L	-		B_VDDOB2_L	-	
A22	B_HDOUTP2_L	-	PCS 361 CH 2 OUT P	B_HDOUTP2_L	-	PCS 361 CH 2 OUT P
K24	VCC12	-		VCC12	-	
F23	B_HDINN2_L	-	PCS 361 CH 2 IN N	B_HDINN2_L	-	PCS 361 CH 2 IN N
E23	B_HDINP2_L	-	PCS 361 CH 2 IN P	B_HDINP2_L	-	PCS 361 CH 2 IN P
D26	B_VDDIB2_L	-		B_VDDIB2_L	-	
G23	VCC12	-		VCC12	-	
D27	B_VDDIB1_L	-		B_VDDIB1_L	-	
G24	VCC12	-		VCC12	-	

LFSC/M40, LFSC/M80 Logic Signal Connections: 1152 fcBGA^{1, 2} (Cont.)

Ball Number	LFSC/M40			LFSC/M80		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
AL11	GND	-		GND	-	
AL17	GND	-		GND	-	
AL21	GND	-		GND	-	
AL27	GND	-		GND	-	
AL5	GND	-		GND	-	
AM14	GND	-		GND	-	
AM18	GND	-		GND	-	
AM24	GND	-		GND	-	
AM30	GND	-		GND	-	
AM8	GND	-		GND	-	
AN1	GND	-		GND	-	
AN34	GND	-		GND	-	
AP2	GND	-		GND	-	
AP33	GND	-		GND	-	
B1	GND	-		GND	-	
B34	GND	-		GND	-	
C11	GND	-		GND	-	
C12	GND	-		GND	-	
C13	GND	-		GND	-	
C14	GND	-		GND	-	
C17	GND	-		GND	-	
C21	GND	-		GND	-	
C22	GND	-		GND	-	
C23	GND	-		GND	-	
C24	GND	-		GND	-	
C26	GND	-		GND	-	
C27	GND	-		GND	-	
C30	GND	-		GND	-	
C31	GND	-		GND	-	
C4	GND	-		GND	-	
C5	GND	-		GND	-	
C8	GND	-		GND	-	
C9	GND	-		GND	-	
D18	GND	-		GND	-	
E32	GND	-		GND	-	
E4	GND	-		GND	-	
F19	GND	-		GND	-	
G16	GND	-		GND	-	
G29	GND	-		GND	-	
G7	GND	-		GND	-	
H3	GND	-		GND	-	
H31	GND	-		GND	-	
J10	GND	-		GND	-	
J15	GND	-		GND	-	
J26	GND	-		GND	-	

LFSC/M115 Logic Signal Connections: 1152 fcBGA^{1, 2}

Ball Number	LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function
AJ34	PL98A	6	
AK34	PL98B	6	
AB27	PL98C	6	
AC27	PL98D	6	
AF33	PL99A	6	
AG33	PL99B	6	
AC29	PL99C	6	
AD29	PL99D	6	
AE31	PL103A	6	
AF31	PL103B	6	
AF30	PL103C	6	
AF29	PL103D	6	
AH33	PL104A	6	
AJ33	PL104B	6	
AC28	PL104C	6	
AD28	PL104D	6	
AH32	PL107A	6	
AJ32	PL107B	6	
AD27	PL107C	6	
AE27	PL107D	6	VREF2_6
AG34	PL109A	6	
AH34	PL109B	6	
AC26	PL109C	6	
AB26	PL109D	6	
AK33	PL112A	6	
AL33	PL112B	6	
AG30	PL112C	6	
AH30	PL112D	6	
AL34	PL115A	6	
AM34	PL115B	6	
AJ30	PL115C	6	LLC_DLLT_IN_E/LLC_DLLT_FB_F
AK30	PL115D	6	LLC_DLLC_IN_E/LLC_DLLC_FB_F
AJ31	PL116A	6	
AH31	PL116B	6	
AD26	PL116C	6	
AD25	PL116D	6	
AL32	PL117A	6	LLC_DLLT_IN_F/LLC_DLLT_FB_E
AL31	PL117B	6	LLC_DLLC_IN_F/LLC_DLLC_FB_E
AG29	PL117C	6	LLC_PLLT_IN_B/LLC_PLLT_FB_A
AG28	PL117D	6	LLC_PLLC_IN_B/LLC_PLLC_FB_A
AF28	XRES	-	
AF27	TEMP	6	
AM33	PB3A	5	LLC_PLLT_IN_A/LLC_PLLT_FB_B

LFSC/M115 Logic Signal Connections: 1152 fcBGA^{1, 2}

Ball Number	LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function
AD5	PR94C	3	
AE2	PR94B	3	
AD2	PR94A	3	
AC5	PR92D	3	
AB5	PR92C	3	
AF1	PR92B	3	
AE1	PR92A	3	
AA11	PR91D	3	
Y11	PR91C	3	
AC4	PR91B	3	
AB4	PR91A	3	
AA8	PR90D	3	DIFFR_3
AA9	PR90C	3	
AC3	PR90B	3	
AB3	PR90A	3	
AA7	PR79D	3	
Y7	PR79C	3	
AA2	PR79B	3	
Y2	PR79A	3	
AA6	PR77D	3	
Y6	PR77C	3	
Y4	PR77B	3	
W4	PR77A	3	
W11	PR74D	3	
V11	PR74C	3	
W2	PR74B	3	
V2	PR74A	3	
W9	PR71D	3	
V9	PR71C	3	
V1	PR71B	3	
U1	PR71A	3	
W10	PR70D	3	
V10	PR70C	3	
U2	PR70B	3	
T2	PR70A	3	
Y8	PR69D	3	
W8	PR69C	3	VREF1_3
W5	PR69B	3	
V5	PR69A	3	
V7	PR66D	3	PCLKC3_2
U7	PR66C	3	PCLKT3_2
T1	PR66B	3	
R1	PR66A	3	

LFSC/M115 Logic Signal Connections: 1152 fcBGA^{1, 2}

Ball Number	LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function
K26	GND	-	
K28	GND	-	
K6	GND	-	
K9	GND	-	
L12	GND	-	
L32	GND	-	
L4	GND	-	
M10	GND	-	
M17	GND	-	
M24	GND	-	
N29	GND	-	
N7	GND	-	
P15	GND	-	
P20	GND	-	
P3	GND	-	
P31	GND	-	
R10	GND	-	
R14	GND	-	
R16	GND	-	
R19	GND	-	
R21	GND	-	
R26	GND	-	
T15	GND	-	
T17	GND	-	
T18	GND	-	
T20	GND	-	
T28	GND	-	
T6	GND	-	
U16	GND	-	
U19	GND	-	
U23	GND	-	
U32	GND	-	
U4	GND	-	
V12	GND	-	
V16	GND	-	
V19	GND	-	
V3	GND	-	
V31	GND	-	
W15	GND	-	
W17	GND	-	
W18	GND	-	
W20	GND	-	
W29	GND	-	

LFSC/M80, LFSC/M115 Logic Signal Connections: 1704 fcBGA^{1, 2} (Cont.)

Ball Number	LFSC/M80			LFSC/M115		
	Ball Function	VCCI/O Bank	Dual Function	Ball Function	VCCI/O Bank	Dual Function
AP1	PR90B	3		PR109B	3	
AN1	PR90A	3		PR109A	3	
AK10	PR89D	3	VREF2_3	PR107D	3	VREF2_3
AJ10	PR89C	3		PR107C	3	
AM5	PR89B	3		PR107B	3	
AL5	PR89A	3		PR107A	3	
AL7	PR86D	3		PR104D	3	
AK7	PR86C	3		PR104C	3	
AM1	PR86B	3		PR104B	3	
AL1	PR86A	3		PR104A	3	
AJ11	PR85D	3		PR103D	3	
AH11	PR85C	3		PR103C	3	
AK5	PR85B	3		PR103B	3	
AJ5	PR85A	3		PR103A	3	
AK9	PR84D	3		PR99D	3	
AJ9	PR84C	3		PR99C	3	
AK3	PR84B	3		PR99B	3	
AJ3	PR84A	3		PR99A	3	
AK6	PR82D	3		PR98D	3	
AJ6	PR82C	3		PR98C	3	
AK2	PR82B	3		PR98B	3	
AJ2	PR82A	3		PR98A	3	
AH10	PR81D	3		PR96D	3	
AG10	PR81C	3		PR96C	3	
AK1	PR81B	3		PR96B	3	
AJ1	PR81A	3		PR96A	3	
AH9	PR80D	3		PR94D	3	
AG9	PR80C	3		PR94C	3	
AH2	PR80B	3		PR94B	3	
AG2	PR80A	3		PR94A	3	
AH8	PR78D	3		PR92D	3	
AG8	PR78C	3		PR92C	3	
AG1	PR78B	3		PR92B	3	
AH1	PR78A	3		PR92A	3	
AG14	PR77D	3		PR91D	3	
AF14	PR77C	3		PR91C	3	
AG4	PR77B	3		PR91B	3	
AF4	PR77A	3		PR91A	3	
AH7	PR76D	3	DIFFR_3	PR90D	3	DIFFR_3
AG7	PR76C	3		PR90C	3	
AG3	PR76B	3		PR90B	3	
AF3	PR76A	3		PR90A	3	
AH6	PR74D	3		PR88D	3	
AG6	PR74C	3		PR88C	3	
AF1	PR74B	3		PR88B	3	

LFSC/M80, LFSC/M115 Logic Signal Connections: 1704 fcBGA^{1, 2} (Cont.)

Ball Number	LFSC/M80			LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
AE1	PR74A	3		PR88A	3	
AF12	PR73D	3		PR87D	3	
AE12	PR73C	3		PR87C	3	
AF2	PR73B	3		PR87B	3	
AE2	PR73A	3		PR87A	3	
AF11	PR72D	3		PR86D	3	
AE11	PR72C	3		PR86C	3	
AF5	PR72B	3		PR86B	3	
AE5	PR72A	3		PR86A	3	
AF10	PR69D	3		PR83D	3	
AE10	PR69C	3		PR83C	3	
AD1	PR69B	3		PR83B	3	
AC1	PR69A	3		PR83A	3	
AF9	PR68D	3		PR82D	3	
AE9	PR68C	3		PR82C	3	
AD2	PR68B	3		PR82B	3	
AC2	PR68A	3		PR82A	3	
AF6	PR67D	3		PR81D	3	
AE6	PR67C	3		PR81C	3	
AD3	PR67B	3		PR81B	3	
AC3	PR67A	3		PR81A	3	
AE8	PR65D	3		PR79D	3	
AD8	PR65C	3		PR79C	3	
AD4	PR65B	3		PR79B	3	
AC4	PR65A	3		PR79A	3	
AE7	PR64D	3		PR78D	3	
AD7	PR64C	3		PR78C	3	
AD5	PR64B	3		PR78B	3	
AC5	PR64A	3		PR78A	3	
AD6	PR63D	3		PR77D	3	
AC6	PR63C	3		PR77C	3	
AB1	PR63B	3		PR77B	3	
AA1	PR63A	3		PR77A	3	
AD9	PR61D	3		PR75D	3	
AC9	PR61C	3		PR75C	3	
AB2	PR61B	3		PR75B	3	
AA2	PR61A	3		PR75A	3	
AD14	PR60D	3		PR74D	3	
AC14	PR60C	3		PR74C	3	
AB5	PR60B	3		PR74B	3	
AA5	PR60A	3		PR74A	3	
AD10	PR59D	3		PR73D	3	
AC10	PR59C	3		PR73C	3	
Y1	PR59B	3		PR73B	3	
W1	PR59A	3		PR73A	3	

LFSC/M80, LFSC/M115 Logic Signal Connections: 1704 fcBGA^{1, 2} (Cont.)

Ball Number	LFSC/M80			LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
D1	A_HDINN0_R	-	PCS 3E0 CH 0 IN N	A_HDINN0_R	-	PCS 3E0 CH 0 IN N
F1	VCC12	-		VCC12	-	
A3	A_HDOUTP0_R	-	PCS 3E0 CH 0 OUT P	A_HDOUTP0_R	-	PCS 3E0 CH 0 OUT P
E1	A_VDDOB0_R	-		A_VDDOB0_R	-	
B3	A_HDOUTN0_R	-	PCS 3E0 CH 0 OUT N	A_HDOUTN0_R	-	PCS 3E0 CH 0 OUT N
C2	A_VDDOB1_R	-		A_VDDOB1_R	-	
A4	A_HDOUTN1_R	-	PCS 3E0 CH 1 OUT N	A_HDOUTN1_R	-	PCS 3E0 CH 1 OUT N
B2	VCC12	-		VCC12	-	
B4	A_HDOUTP1_R	-	PCS 3E0 CH 1 OUT P	A_HDOUTP1_R	-	PCS 3E0 CH 1 OUT P
E3	A_HDINN1_R	-	PCS 3E0 CH 1 IN N	A_HDINN1_R	-	PCS 3E0 CH 1 IN N
D3	A_HDINP1_R	-	PCS 3E0 CH 1 IN P	A_HDINP1_R	-	PCS 3E0 CH 1 IN P
M10	VCC12	-		VCC12	-	
E2	A_VDDIB1_R	-		A_VDDIB1_R	-	
J11	VCC12	-		VCC12	-	
M11	A_VDDIB2_R	-		A_VDDIB2_R	-	
D4	A_HDINP2_R	-	PCS 3E0 CH 2 IN P	A_HDINP2_R	-	PCS 3E0 CH 2 IN P
E4	A_HDINN2_R	-	PCS 3E0 CH 2 IN N	A_HDINN2_R	-	PCS 3E0 CH 2 IN N
K9	VCC12	-		VCC12	-	
A5	A_HDOUTP2_R	-	PCS 3E0 CH 2 OUT P	A_HDOUTP2_R	-	PCS 3E0 CH 2 OUT P
D2	A_VDDOB2_R	-		A_VDDOB2_R	-	
B5	A_HDOUTN2_R	-	PCS 3E0 CH 2 OUT N	A_HDOUTN2_R	-	PCS 3E0 CH 2 OUT N
L10	A_VDDOB3_R	-		A_VDDOB3_R	-	
B6	A_HDOUTN3_R	-	PCS 3E0 CH 3 OUT N	A_HDOUTN3_R	-	PCS 3E0 CH 3 OUT N
G6	VCC12	-		VCC12	-	
A6	A_HDOUTP3_R	-	PCS 3E0 CH 3 OUT P	A_HDOUTP3_R	-	PCS 3E0 CH 3 OUT P
E5	A_HDINN3_R	-	PCS 3E0 CH 3 IN N	A_HDINN3_R	-	PCS 3E0 CH 3 IN N
D5	A_HDINP3_R	-	PCS 3E0 CH 3 IN P	A_HDINP3_R	-	PCS 3E0 CH 3 IN P
K12	VCC12	-		VCC12	-	
L13	A_VDDIB3_R	-		A_VDDIB3_R	-	
N14	VCC12	-		VCC12	-	
F9	B_VDDIB0_R	-		B_VDDIB0_R	-	
D6	B_HDINP0_R	-	PCS 3E1 CH 0 IN P	B_HDINP0_R	-	PCS 3E1 CH 0 IN P
E6	B_HDINN0_R	-	PCS 3E1 CH 0 IN N	B_HDINN0_R	-	PCS 3E1 CH 0 IN N
J8	VCC12	-		VCC12	-	
B7	B_HDOUTP0_R	-	PCS 3E1 CH 0 OUT P	B_HDOUTP0_R	-	PCS 3E1 CH 0 OUT P
G4	B_VDDOB0_R	-		B_VDDOB0_R	-	
A7	B_HDOUTN0_R	-	PCS 3E1 CH 0 OUT N	B_HDOUTN0_R	-	PCS 3E1 CH 0 OUT N
K8	B_VDDOB1_R	-		B_VDDOB1_R	-	
A8	B_HDOUTN1_R	-	PCS 3E1 CH 1 OUT N	B_HDOUTN1_R	-	PCS 3E1 CH 1 OUT N
L9	VCC12	-		VCC12	-	
B8	B_HDOUTP1_R	-	PCS 3E1 CH 1 OUT P	B_HDOUTP1_R	-	PCS 3E1 CH 1 OUT P
E7	B_HDINN1_R	-	PCS 3E1 CH 1 IN N	B_HDINN1_R	-	PCS 3E1 CH 1 IN N
D7	B_HDINP1_R	-	PCS 3E1 CH 1 IN P	B_HDINP1_R	-	PCS 3E1 CH 1 IN P
F10	VCC12	-		VCC12	-	
K13	B_VDDIB1_R	-		B_VDDIB1_R	-	

Commercial, Cont.

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSC3GA80E-7FCN1152C ¹	-7	Lead-Free Ceramic fcBGA	1152	COM	80.1
LFSC3GA80E-6FCN1152C ¹	-6	Lead-Free Ceramic fcBGA	1152	COM	80.1
LFSC3GA80E-5FCN1152C ¹	-5	Lead-Free Ceramic fcBGA	1152	COM	80.1
LFSC3GA80E-7FFN1152C	-7	Lead-Free Organic fcBGA	1152	COM	80.1
LFSC3GA80E-6FFN1152C	-6	Lead-Free Organic fcBGA	1152	COM	80.1
LFSC3GA80E-5FFN1152C	-5	Lead-Free Organic fcBGA	1152	COM	80.1
LFSC3GA80E-7FCN1704C ¹	-7	Lead-Free Ceramic fcBGA	1704	COM	80.1
LFSC3GA80E-6FCN1704C ¹	-6	Lead-Free Ceramic fcBGA	1704	COM	80.1
LFSC3GA80E-5FCN1704C ¹	-5	Lead-Free Ceramic fcBGA	1704	COM	80.1
LFSC3GA80E-7FFN1704C	-7	Lead-Free Organic fcBGA	1704	COM	80.1
LFSC3GA80E-6FFN1704C	-6	Lead-Free Organic fcBGA	1704	COM	80.1
LFSC3GA80E-5FFN1704C	-5	Lead-Free Organic fcBGA	1704	COM	80.1

1. Converted to organic flip-chip BGA package per [PCN #01A-10](#).

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSCM3GA80EP1-7FCN1152C ¹	-7	Lead-Free Ceramic fcBGA	1152	COM	80.1
LFSCM3GA80EP1-6FCN1152C ¹	-6	Lead-Free Ceramic fcBGA	1152	COM	80.1
LFSCM3GA80EP1-5FCN1152C ¹	-5	Lead-Free Ceramic fcBGA	1152	COM	80.1
LFSCM3GA80EP1-7FFN1152C	-7	Lead-Free Organic fcBGA	1152	COM	80.1
LFSCM3GA80EP1-6FFN1152C	-6	Lead-Free Organic fcBGA	1152	COM	80.1
LFSCM3GA80EP1-5FFN1152C	-5	Lead-Free Organic fcBGA	1152	COM	80.1
LFSCM3GA80EP1-7FCN1704C ¹	-7	Lead-Free Ceramic fcBGA	1704	COM	80.1
LFSCM3GA80EP1-6FCN1704C ¹	-6	Lead-Free Ceramic fcBGA	1704	COM	80.1
LFSCM3GA80EP1-5FCN1704C ¹	-5	Lead-Free Ceramic fcBGA	1704	COM	80.1
LFSCM3GA80EP1-7FFN1704C	-7	Lead-Free Organic fcBGA	1704	COM	80.1
LFSCM3GA80EP1-6FFN1704C	-6	Lead-Free Organic fcBGA	1704	COM	80.1
LFSCM3GA80EP1-5FFN1704C	-5	Lead-Free Organic fcBGA	1704	COM	80.1

1. Converted to organic flip-chip BGA package per [PCN #01A-10](#).

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSC3GA115E-6FCN1152C ¹	-6	Lead-Free Ceramic fcBGA	1152	COM	115.2
LFSC3GA115E-5FCN1152C ¹	-5	Lead-Free Ceramic fcBGA	1152	COM	115.2
LFSC3GA115E-6FFN1152C	-6	Lead-Free Organic fcBGA	1152	COM	115.2
LFSC3GA115E-5FFN1152C	-5	Lead-Free Organic fcBGA	1152	COM	115.2
LFSC3GA115E-6FCN1704C ¹	-6	Lead-Free Ceramic fcBGA	1704	COM	115.2
LFSC3GA115E-5FCN1704C ¹	-5	Lead-Free Ceramic fcBGA	1704	COM	115.2
LFSC3GA115E-6FFN1704C	-6	Lead-Free Organic fcBGA	1704	COM	115.2
LFSC3GA115E-5FFN1704C	-5	Lead-Free Organic fcBGA	1704	COM	115.2

1. Converted to organic flip-chip BGA package per [PCN #01A-10](#).

Commercial, Cont.

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSCM3GA115EP1-6FCN1152C ¹	-6	Lead-Free Ceramic fcBGA	1152	COM	115.2
LFSCM3GA115EP1-5FCN1152C ¹	-5	Lead-Free Ceramic fcBGA	1152	COM	115.2
LFSCM3GA115EP1-6FFN1152C	-6	Lead-Free Organic fcBGA	1152	COM	115.2
LFSCM3GA115EP1-5FFN1152C	-5	Lead-Free Organic fcBGA	1152	COM	115.2
LFSCM3GA115EP1-6FCN1704C ¹	-6	Lead-Free Ceramic fcBGA	1704	COM	115.2
LFSCM3GA115EP1-5FCN1704C ¹	-5	Lead-Free Ceramic fcBGA	1704	COM	115.2
LFSCM3GA115EP1-6FFN1704C	-6	Lead-Free Organic fcBGA	1704	COM	115.2
LFSCM3GA115EP1-5FFN1704C	-5	Lead-Free Organic fcBGA	1704	COM	115.2

1. Converted to organic flip-chip BGA package per [PCN #01A-10](#).

Industrial, Cont.

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSCM3GA40EP1-6FFN1020I ¹	-6	Lead-Free Organic fcBGA	1020	IND	40.4
LFSCM3GA40EP1-5FFN1020I ¹	-5	Lead-Free Organic fcBGA	1020	IND	40.4
LFSCM3GA40EP1-6FFAN1020I	-6	Lead-Free Organic fcBGA Revision 2	1020	IND	40.4
LFSCM3GA40EP1-5FFAN1020I	-5	Lead-Free Organic fcBGA Revision 2	1020	IND	40.4
LFSCM3GA40EP1-6FCN1152I ²	-6	Lead-Free Ceramic fcBGA	1152	IND	40.4
LFSCM3GA40EP1-5FCN1152I ²	-5	Lead-Free Ceramic fcBGA	1152	IND	40.4
LFSCM3GA40EP1-6FFN1152I	-6	Lead-Free Organic fcBGA	1152	IND	40.4
LFSCM3GA40EP1-5FFN1152I	-5	Lead-Free Organic fcBGA	1152	IND	40.4

1. Converted to organic flip-chip BGA package revision 2 per [PCN #02A-10](#).2. Converted to organic flip-chip BGA package per [PCN #01A-10](#).

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSC3GA80E-6FCN1152I ¹	-6	Lead-Free Ceramic fcBGA	1152	IND	80.1
LFSC3GA80E-5FCN1152I ¹	-5	Lead-Free Ceramic fcBGA	1152	IND	80.1
LFSC3GA80E-6FFN1152I	-6	Lead-Free Organic fcBGA	1152	IND	80.1
LFSC3GA80E-5FFN1152I	-5	Lead-Free Organic fcBGA	1152	IND	80.1
LFSC3GA80E-6FCN1704I ¹	-6	Lead-Free Ceramic fcBGA	1704	IND	80.1
LFSC3GA80E-5FCN1704I ¹	-5	Lead-Free Ceramic fcBGA	1704	IND	80.1
LFSC3GA80E-6FFN1704I	-6	Lead-Free Organic fcBGA	1704	IND	80.1
LFSC3GA80E-5FFN1704I	-5	Lead-Free Organic fcBGA	1704	IND	80.1

1. Converted to organic flip-chip BGA package per [PCN #01A-10](#).

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSCM3GA80EP1-6FCN1152I ¹	-6	Lead-Free Ceramic fcBGA	1152	IND	80.1
LFSCM3GA80EP1-5FCN1152I ¹	-5	Lead-Free Ceramic fcBGA	1152	IND	80.1
LFSCM3GA80EP1-6FFN1152I	-6	Lead-Free Organic fcBGA	1152	IND	80.1
LFSCM3GA80EP1-5FFN1152I	-5	Lead-Free Organic fcBGA	1152	IND	80.1
LFSCM3GA80EP1-6FCN1704I ¹	-6	Lead-Free Ceramic fcBGA	1704	IND	80.1
LFSCM3GA80EP1-5FCN1704I ¹	-5	Lead-Free Ceramic fcBGA	1704	IND	80.1
LFSCM3GA80EP1-6FFN1704I	-6	Lead-Free Organic fcBGA	1704	IND	80.1
LFSCM3GA80EP1-5FFN1704I	-5	Lead-Free Organic fcBGA	1704	IND	80.1

1. Converted to organic flip-chip BGA package per [PCN #01A-10](#).

Date	Version	Section	Change Summary
December 2011	02.4	DC and Switching Characteristics	Updated JTAG Port Timing Specifications table.